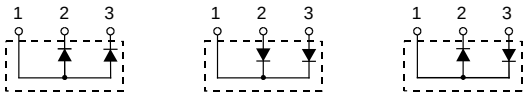
IXYS

Fast Recovery Epitaxial Diode (FRED) Module

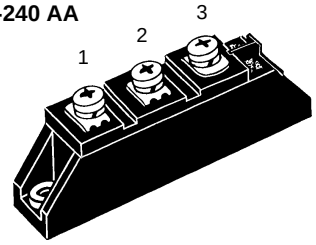
MEA 95-06 DA
MEK 95-06 DA
MEE 95-06 DA

V_{RRM} = 600 V
I_{FAV} = 95 A
t_{rr} = 250 ns

V_{RSM} V	V_{RRM} V	Type
600	600	MEA95-06 DA / MEK 95-06 DA / MEE 95-06 DA



TO-240 AA



Symbol	Test Conditions		Maximum Ratings	
I_{FRMS}	T_{case} = 75°C		142	A
I_{FAV} ①	T_{case} = 75°C; rectangular, d = 0.5		95	A
I_{FRM}	t_P < 10 µs; rep. rating, pulse width limited by T_{VJM}		TBD	A
I_{FSM}	T_{VJ} = 45°C;	t = 10 ms (50 Hz), sine	1200	A
		t = 8.3 ms (60 Hz), sine	1300	A
	T_{VJ} = 150°C;	t = 10 ms (50 Hz), sine	1080	A
		t = 8.3 ms (60 Hz), sine	1170	A
I^2t	T_{VJ} = 45°C;	t = 10 ms (50 Hz), sine	7200	A^2s
		t = 8.3 ms (60 Hz), sine	7100	A^2s
	T_{VJ} = 150°C;	t = 10 ms (50 Hz), sine	5800	A^2s
		t = 8.3 ms (60 Hz), sine	5700	A^2s
T_{VJ}			-40...+150	°C
T_{stg}			-40...+125	°C
T_{Hmax}			110	°C
P_{tot}	T_{case} = 25°C		280	W
V_{ISOL}	50/60 Hz, RMS	t = 1 min	3000	V~
	$I_{ISOL} \leq$ 1 mA	t = 1 s	3600	V~
M_d	Mounting torque (M5)		2.5-4/22-35	Nm/lb.in.
	Terminal connection torque (M5)		2.5-4/22-35	Nm/lb.in.
d_S	Creep distance on surface		12.7	mm
d_A	Strike distance through air		9.6	mm
a	Maximum allowable acceleration		50	m/s^2
Weight			90	g

Symbol	Test Conditions		Characteristic Values (per diode) typ.	max.	
I_R	T_{VJ} = 25°C	$V_R = V_{RRM}$		2	mA
	T_{VJ} = 25°C	V_R = 0.8 • V_{RRM}		0.5	mA
	T_{VJ} = 125°C	V_R = 0.8 • V_{RRM}		34	mA
V_F	I_F = 100 A;	T_{VJ} = 125°C		1.36	V
		T_{VJ} = 25°C		1.55	V
	I_F = 300 A;	T_{VJ} = 125°C		2.05	V
		T_{VJ} = 25°C		2.09	V
V_{T0}	For power-loss calculations only			1.01	V
r_T	T_{VJ} = 125°C			2.85	mΩ
R_{thJH}	DC current			0.550	K/W
R_{thJC}	DC current			0.450	K/W
t_{rr}	I_F = 100 A	T_{VJ} = 100°C	250	300	ns
I_{RM}	V_R = 300 V	T_{VJ} = 25°C		14	A
	-di/dt = 200 A/µs	T_{VJ} = 100°C		21	A

Features

- International standard package with DCB ceramic base plate
- Planar passivated chips
- Short recovery time
- Low switching losses
- Soft recovery behaviour
- Isolation voltage 3600 V~
- UL registered E 72873

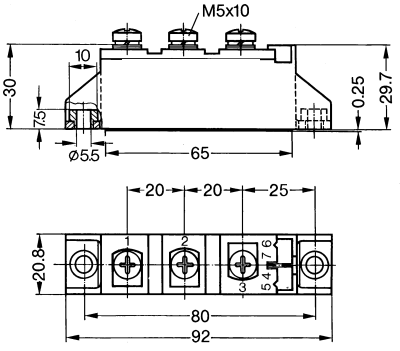
Applications

- Antiparallel diode for high frequency switching devices
- Free wheeling diode in converters and motor control circuits
- Inductive heating and melting
- Uninterruptible power supplies (UPS)
- Ultrasonic cleaners and welders

Advantages

- High reliability circuit operation
- Low voltage peaks for reduced protection circuits
- Low noise switching
- Low losses

Dimensions in mm (1 mm = 0.0394")



① I_{FAV} rating includes reverse blocking losses at T_{VJM}, V_R = 0.6 V_{RRM}, duty cycle d = 0.5
Data according to IEC 60747
IXYS reserves the right to change limits, test conditions and dimensions

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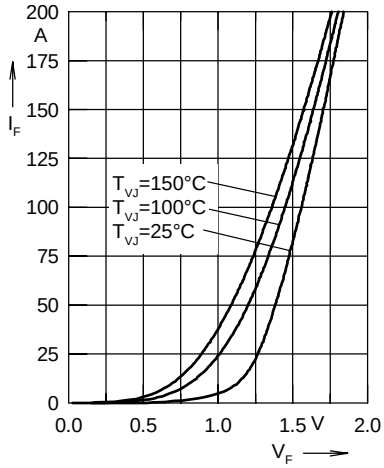

Fig. 1 Forward current I_F versus voltage drop V_F per leg

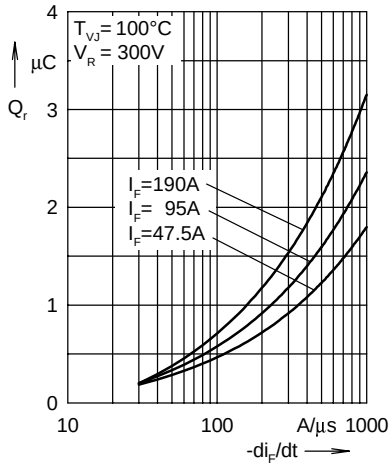

Fig. 2 Reverse recovery charge Q_r versus $-di_F/dt$

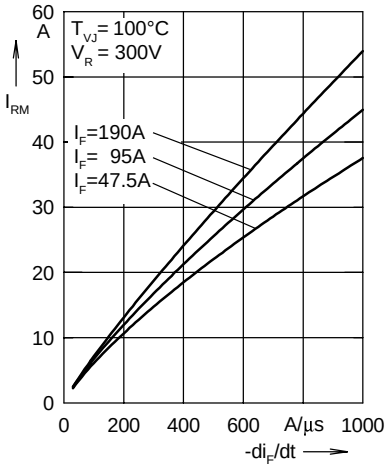

Fig. 3 Peak reverse current I_{RM} versus $-di_F/dt$

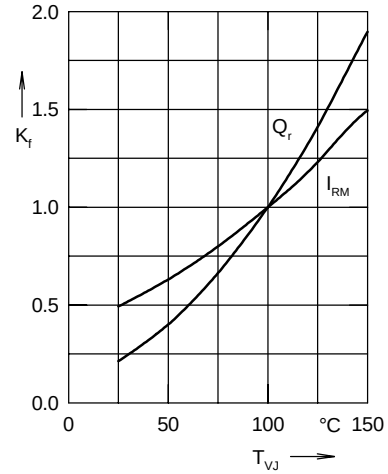

Fig. 4 Dynamic parameters Q_r, I_{RM} versus junction temperature T_{VJ}

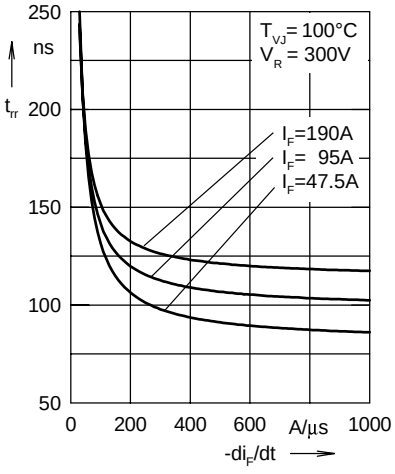

Fig. 5 Recovery time t_{rr} versus $-di_F/dt$

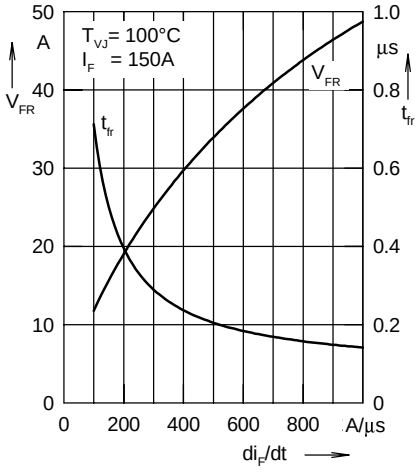

Fig. 6 Peak forward voltage V_{FR} and t_{fr} versus di_F/dt

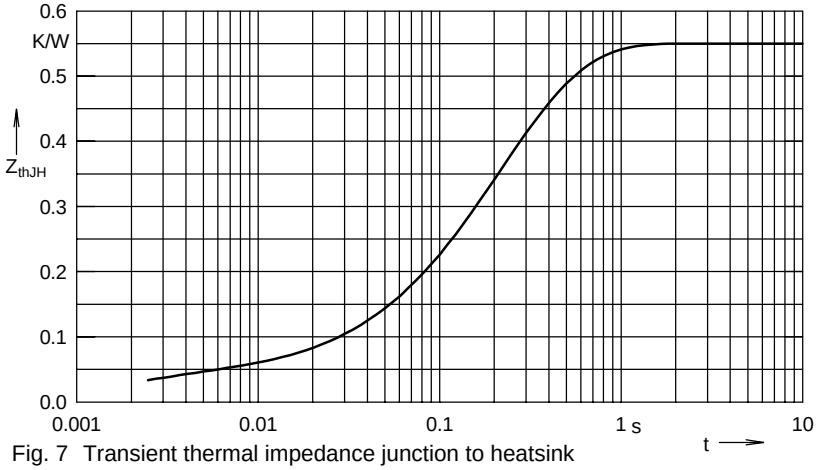

Fig. 7 Transient thermal impedance junction to heatsink

Constants for Z_{thJH} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.037	0.002
2	0.138	0.134
3	0.093	0.25
4	0.282	0.274